



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION OF

Confirmation No.: 5709

~~NAKAGAWA~~

Group Art Unit: 2841

~~Appn. No.: 09/654,412~~

Examiner: T. PHAN

~~Filed: September 1, 2000~~

#18/Response
RE
5/1/03

Title: COMPONENT MOUNTING CIRCUIT BOARD WITH RESIN-MOLDED SECTION
COVERING CIRCUIT PATTERN AND INNER COMPONENTS

April 28, 2003

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AMENDMENT

Hon. Commissioner of Patents
Washington, D.C. 20231

Sir:

In response to the Office Action dated January 28, 2003, please amend the above identified application as follows:

This Amendment is being presented in the REVISED FORMAT approved in February, 2003.

RECEIVED
APR 30 2003
TECHNOLOGY CENTER 2800